

March 2015

FDPF770N15A

N-Channel PowerTrench[®] MOSFET 150 V, 10 A, 77 m Ω

Features

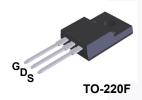
- $R_{DS(on)}$ = 60 m Ω (Typ.) @ V_{GS} = 10 V, I_D = 10 A
- · Fast Switching Speed
- · Low Gate Charge
- High Performance Trench Technology for Extremely Low $R_{DS(on)}$
- · High Power and Current Handling Capability
- · RoHS Compliant

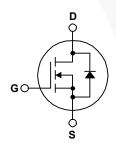
Description

This N-Channel MOSFET is produced using Fairchild Semiconductor's advanced PowerTrench® process that has been tailored to minimize the on-state resistance while maintaining superior switching performance.

Applications

- · Consumer Appliances
- LED TV
- · Synchronous Rectification for ATX / Sever / Telecom PSU
- · Uninterruptible Power Supply
- · Micro Solar Inverter





Absolute Maximum Ratings T_C = 25°C unless otherwise noted.

Symbol		FDPF770N15A	Unit		
V _{DSS}	Drain to Source Voltage		150	V	
Cata ta Causaa Valtana		- DC	±20	V	
V _{GSS} Ga	Gate to Source Voltage	- AC (f > 1 Hz)	±30	V	
I _D	Drain Current	- Continuous (T _C = 25°C,Silicon Limited)	10	A	
	Drain Current	- Continuous (T _C = 100°C,Silicon Limited)	7		
I _{DM}	Drain Current	- Pulsed (Note 1)	40	Α	
E _{AS}	Single Pulsed Avalanche Energy	35	mJ		
dv/dt	Peak Diode Recovery dv/dt	(Note 3)	6.0	V/ns	
n	Dawer Discipation	$(T_C = 25^{\circ}C)$	21	W	
P_{D}	Power Dissipation	- Derate Above 25°C	0.17	W/°C	
T _J , T _{STG}	Operating and Storage Temperat	-55 to +150	°C		
Tı	Maximum Lead Temperature for	300	°C		

Thermal Characteristics

Symbol	Parameter	FDPF770N15A	Unit
$R_{\theta JC}$	Thermal Resistance, Junction to Case, Max.	5.9	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient, Max. 62.5		*C/VV

Package Marking and Ordering Information

Part Number	Top Mark	Package	Packing Method	Reel Size	Tape Width	Quantity
FDPF770N15A	FDPF770N15A	TO-220F	Tube	N/A	N/A	50 units

Electrical Characteristics $T_C = 25^{\circ}C$ unless otherwise noted.

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
Off Charac	cteristics					
BV _{DSS}	Drain to Source Breakdown Voltage	$I_D = 250 \mu A, V_{GS} = 0 V$	150	-	-	V
ΔBV _{DSS} / ΔΤ _J	Breakdown Voltage Temperature Coefficient	I_D = 250 μA, Referenced to 25°C	-	0.1	-	V/°C
1	Zoro Coto Voltago Droin Current	V _{DS} = 120 V, V _{GS} = 0 V	-	-	1	
IDSS	Zero Gate Voltage Drain Current	$V_{DS} = 120 \text{ V}, T_{C} = 125^{\circ}\text{C}$	-	-	500	μA
I _{GSS}	Gate to Body Leakage Current	V _{GS} = ±20 V, V _{DS} = 0 V	-	-	±100	nA

On Characteristics

V _{GS(th)}	Gate Threshold Voltage	$V_{GS} = V_{DS}, I_D = 250 \mu A$	2.0	-	4.0	V
R _{DS(on)}	Static Drain to Source On Resistance	V _{GS} = 10 V, I _D = 10 A	-	60	77	mΩ
9 _{FS}	Forward Transconductance	V _{DS} = 10 V, I _D = 10 A	-	15	-	S

Dynamic Characteristics

C _{iss}	Input Capacitance	V _{DS} = 75 V, V _{GS} = 0 V, f = 1 MHz		575	765	pF
C _{oss}	Output Capacitance			64	85	pF
C _{rss}	Reverse Transfer Capacitance			3.9	-	pF
C _{oss(er)}	Energy Related Output Capacitance	V _{DS} = 75 V, V _{GS} = 0 V		113	-	pF
Q _{g(tot)}	Total Gate Charge at 10V		- \	8.6	11.2	nC
Q_{gs}	Gate to Source Gate Charge	V _{DS} = 75 V,I _D = 10 A,		3.2	-	nC
Q _{gs2}	Gate Charge Threshold to Plateau	V _{GS} = 10 V	-	1.2	-	nC
Q_{gd}	Gate to Drain "Miller" Charge	(Note 4	-	1.9	-	nC
ESR	Equivalent Series Resistance (G-S)	f = 1 MHz	-	0.5	-	Ω

Switching Characteristics

t _{d(on)}	Turn-On Delay Time		-	12	34	ns
t _r	Turn-On Rise Time	$V_{DD} = 75 \text{ V, I}_{D} = 10 \text{ A,}$	-	8	26	ns
t _{d(off)}	Turn-Off Delay Time	$V_{GS} = 10 \text{ V}, R_{G} = 4.7 \Omega$	-	15	40	ns
t _f	Turn-Off Fall Time	(Note 4)	-	3	16	ns

Drain-Source Diode Characteristics

IS	Maximum Continuous Drain to Source Diode Forward Current			-	10	Α
I _{SM}	Maximum Pulsed Drain to Source Diode Forward Current			-	40	Α
V_{SD}	Drain to Source Diode Forward Voltage V _{GS} = 0 V, I _{SD} = 10 A		-	- ,,,/	1.25	V
t _{rr}	Reverse Recovery Time $V_{GS} = 0 \text{ V}, I_{SD} = 10 \text{ A}, V_{DD} = 75 \text{ V},$		-	59		ns
Q _{rr}	Reverse Recovery Charge dI _F /dt = 100 A/μs		-	124	-	nC

Notes

- 1. Repetitive rating: pulse-width limited by maximum junction temperature.
- 2. Starting T_J = 25°C, L = 3 mH, I_{SD} = 4.8 A.
- 3. I $_{SD} \leq$ 10 A, di/dt \leq 200 A/ $\mu s,~V_{DD} \leq$ BV $_{DSS},$ starting T $_{J}$ = 25°C.
- 4. Essentially independent of operating temperature typical characteristics.

Typical Performance Characteristics

Figure 1. On-Region Characteristics

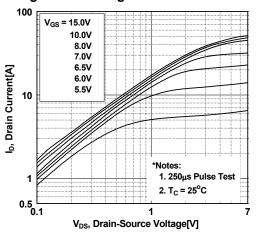


Figure 3. On-Resistance Variation vs.

Drain Current and Gate Voltage

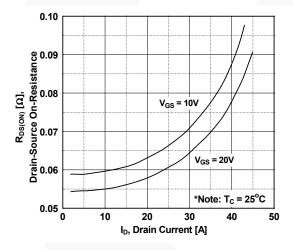


Figure 5. Capacitance Characteristics

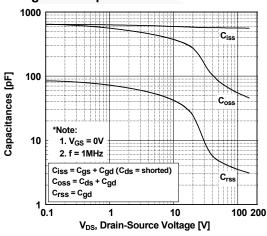


Figure 2. Transfer Characteristics

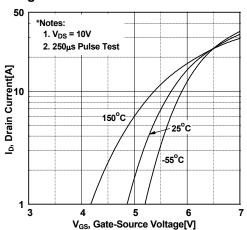


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

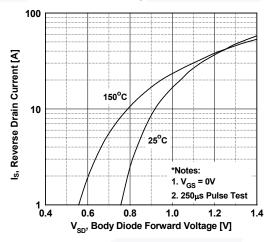
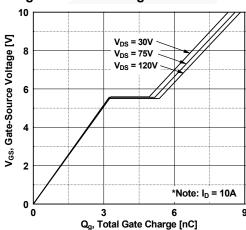


Figure 6. Gate Charge Characteristics



Typical Performance Characteristics (Continued)

Figure 7. Breakdown Voltage Variation vs. Temperature

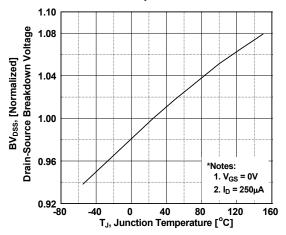


Figure 8. On-Resistance Variation vs. Temperature

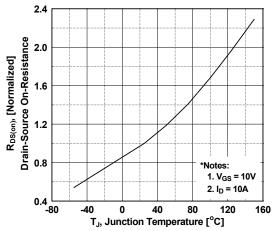


Figure 9. Maximum Safe Operating Area

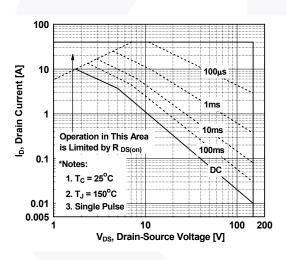


Figure 10. Maximum Drain Current vs. Case Temperature

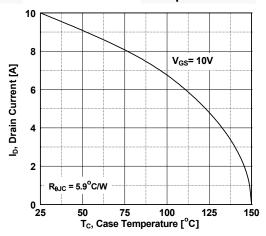
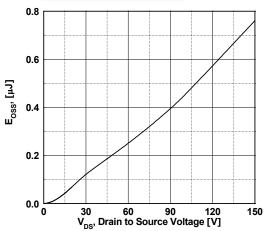
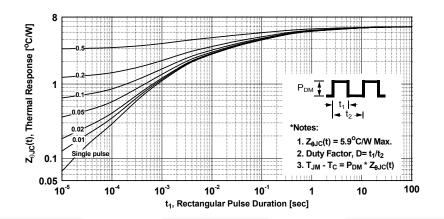


Figure 11. Eoss vs. Drain to Source Voltage



Typical Performance Characteristics (Continued)





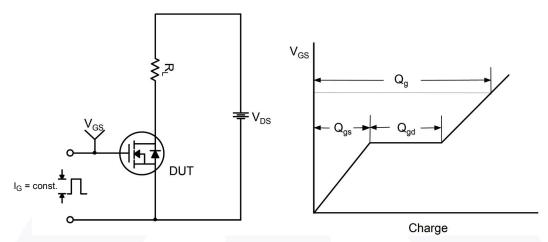


Figure 13. Gate Charge Test Circuit & Waveform

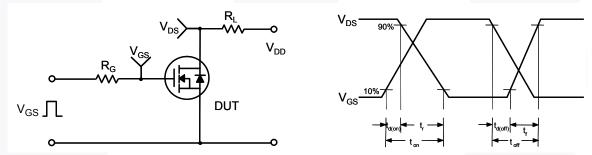


Figure 14. Resistive Switching Test Circuit & Waveforms

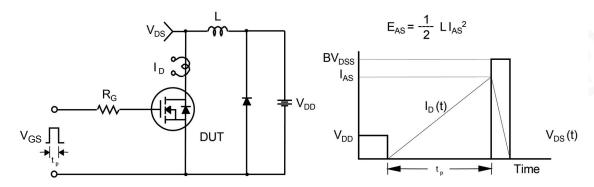


Figure 15. Unclamped Inductive Switching Test Circuit & Waveforms

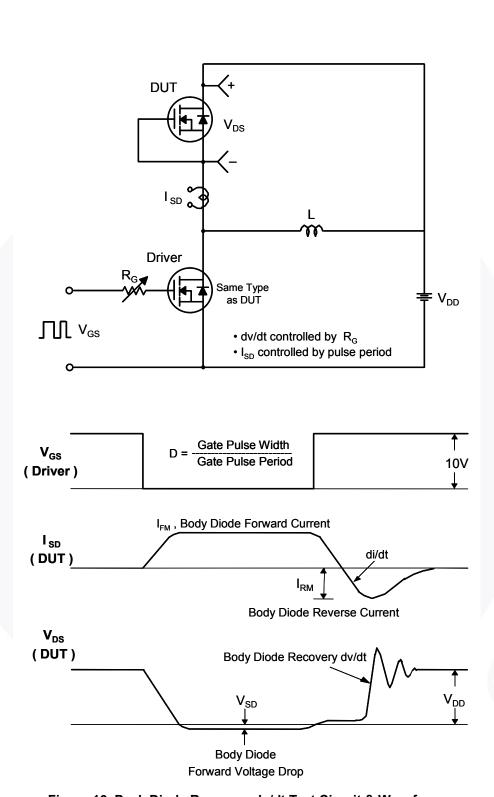
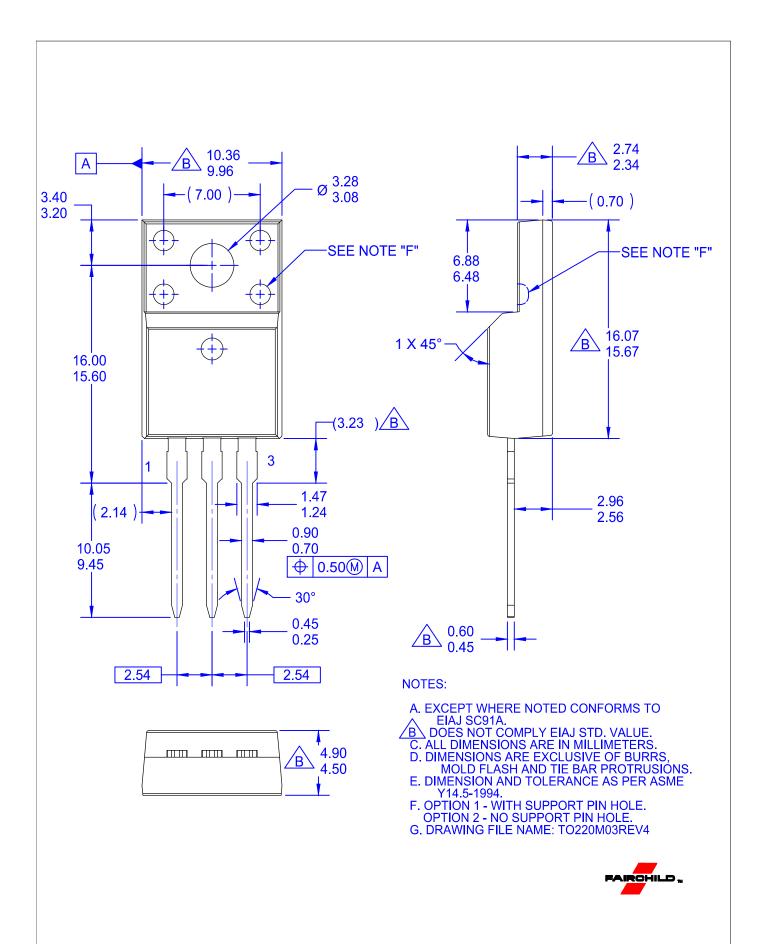


Figure 16. Peak Diode Recovery dv/dt Test Circuit & Waveforms







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Definition of Terms

Deminition of Terms		
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